

S/N 09/660757

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Qing Ma Examiner: Roy K. Potter
Serial No.: 09/660757 Group Art Unit: 2822
Filed: September 13, 2000 Docket: 884.803US1
Title: DIRECT BUILD-UP LAYER ON AN ENCAPSULATED DIE PACKAGE
HAVING A MOISTURE BARRIER STRUCTURE
Assignee: Intel Corporation

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

COMMUNICATION UNDER 37 C.F.R. § 1.312(a)

In response to the Notice of Allowance and Notice of Allowability mailed October 8, 2003, please note the following:

Information Disclosure Statement

Applicant filed an Information Disclosure Statement with the U.S. Patent Office on January 31, 2001 in connection with the above-identified patent application. To date, Applicant has not received a copy of the Form 1449 marked as considered by the Examiner. Applicant requests that a copy of said Form 1449 be initialed by the Examiner to indicate consideration of the cited documents, and that the Form 1449 be returned with the next official communication.

Copies of the Information Disclosure Statement and Form 1449 are enclosed for the Examiner's convenience. Additionally enclosed is a copy of the date-stamped itemized postcard for the Information Disclosure Statement as evidence of receipt of same by the U.S. Patent Office.

It is believed that no fee is necessary for the present submission. However, if any fees are deemed necessary, please charge any additional fees or credit any overpayment to Account No. 19-0743.

Please contact Applicants' representative, John Greaves, at (801) 278-9171, or Applicants' below-named representative at (612) 349-9592 if any assistance is required in this matter.

Respectfully submitted,

QING MA

By his Representatives,

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Date Jan. 8, 2004

By Ann M. McCrackin

Ann M. McCrackin

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 8 day of JANUARY, 2004.

MEREDITH MESCHER
Name

Meredith Mescher
Signature